molex

Supporting next-generation 100 Gbps Ethernet and 100 Gbps InfiniBand* Enhanced Data Rate (EDR) applications, Molex's zQSFP+ Interconnect Solution transmits up to 25 Gbps per-serial-lane data rates with excellent signal integrity (SI), electro magnetic interference (EMI) protection and thermal cooling

Molex's zQuad Small Form-factor Pluggable Plus (zQSFP+) interconnect solution is designed for high-density interconnect applications and conforms to SFF-8665 QSFP28. Components of the system include SMT connectors (series 170432); stacked integrated 2-by-1, 2-by-2 and 2-by-3 connectors and cages (series 171565, 171722); EMI cages (Series 111118, 111186, 100014, 100017, 100086); Optical MPO/MTP* Cable Assemblies (Series 106283); Optical MPO/MTP Loopback Adapters (Series 106005). Products scheduled for upcoming release include: copper passive cable assemblies (Series 111114); active optical cables (Series 106412).

Molex's zQSFP+ SMT connector supports new 100 Gbps Ethernet and 100 Gbps InfiniBand* (IB) Enhanced Data Rate (EDR) applications. EDR applications consist of four lanes of high-speed differential signals with individual data rates at 25 Gbps. The preferential coupling design uses a narrow-edge coupled, blanked- and formed-contact geometry and insert molding to optimize electrical performance. The zQSFP+ connector shares the same mating interface as the QSFP+ form factor, making it backward compatible with current cable assemblies.

zQSFP+ EMI cages are designed with an advanced heat-sink system to provide a high level of heat dissipation for next-generation system-power levels. Die-cast design features screw-down option to the PCB for maximum board retention. The spring-finger design provides optimal EMI grounding and allows for more space to route high-speed traces. Single-height, spring-finger cages feature a 3D press-pin design for superior board retention.

Future low-power, integrated active optical cable (AOC) solutions will provide less expensive, reliable transport for aggregated data rates up to 100 Gbps. The singlemode fiber technology will provide long reaches of up to 4km, enabling deployment in data centers and campus environments.

zQuad Small Formfactor Pluggable Plus (zQSFP+) Interconnect System

171722 Stacked Integrated 2-by-1, 2-by-2 and 2-by-3 Connectors and Cages, Spring-Finger EMI Gasket

100014 EMI Cages, 1-by-1, Sheet Metal

100017 EMI Cages, 1-by-4, Ganged, Sheet Metal

100086 EMI Cages, 1-by-6, Ganged, Sheet Metal

170432 SMT Connectors

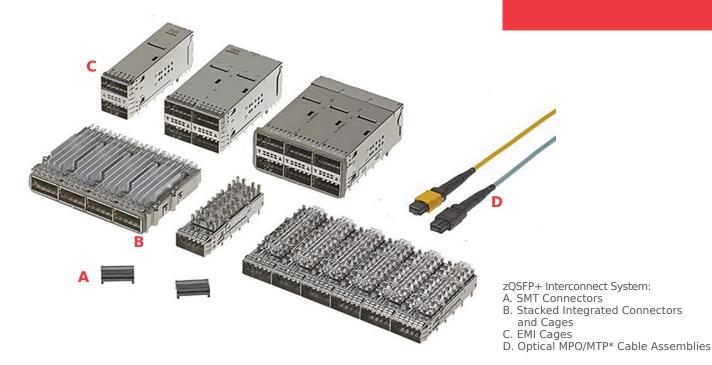
171565 Stacked Integrated 2-by-1, 2-by-2 and 2-by-3 Connectors and Cages, Elastomeric EMI Gasket

111118 EMI Cages, 1-by-4 Ganged, Die-Cast

111186 EMI Cages, 1-by-6 Ganged, Die-Cast

106283 Optical MPO/MTP[†] Cable Assemblies

106005 Optical MPO/MTP Loopback Adapters



molex[®]

Specifications

SMT Connectors

Reference Information

Packaging: Tape and Reel UL File No.: E29179 CSA File No.: LR19980

Mates With:

Copper Cable Assemblies (Series 74757, 111040) Designed In: Millimeters

Electrical

Voltage: 30V

Current: 0.5A max.; power contacts

1.0A max.

Contact Resistance: 30 milliohms max. Dielectric Withstanding Voltage: 500V AC

Insulation Resistance: 1000 Megohms min.

Mechanical

Contact Retention to Housing: 4.45N Mating Force: 1.25N per circuit Unmating Force: 0.25N per circuit Durability:

250 cycles for 30μ" Gold (Au) plating

Physical

Housing:

High-Temperature Thermoplastic Glass Filled, UL 94V-0, Black Contact: Copper (Cu) Alloy

Plating:

Contact Area — 15µ" (0.38µm) or 30µ" (0.76µm) Gold (Au) Solder Tail Area — Tin (Sn) Underplating — Nickel (Ni)

RoHS Compliant: Yes

Operating Temperature: -40 to +80°C

Optical MPO/MTP* Cable Assemblies
Reference Information

Packaging: Individual pack in a bag Mates With: QSFP+ Modules

Optical

Fiber Specifications: Multi Mode: 50/125µm Insertion Loss at Test:

Multi Mode: 0.15dB; Typ.; ≤0.5dB max.

Bandwidth: See Bandwidth

Reference Chart

Mechanical

Minimum Bend Radius: 31.75mm

(1.25") long-term

Physical

Fire Rating: OFNP (Plenum) Operating Temp: 0 to +70°C Storage Temp: -40 to +70°C lacket Dimensions:

1 to 30 Meters: 3.1mm Interconnect Cables 31 to 300 Meters: 4.5mm Distribution Cables **Stacked Integrated Connectors** and Cages

Reference Information

Packaging: Tray UL File No.: E29179

Mates With:

Copper Cable Assemblies (Series 74757, 111040) Designed In: Millimeters

Electrical

Voltage: 30V

Current: 0.5A max.; power contacts

1.0A max.

Contact Resistance: 30 milliohms max. Dielectric Withstanding Voltage:

500V AC

Insulation Resistance:

1000 Megohms min.

Mechanical

Mating Force: 0.75N per circuit Unmating Force: 0.25N per circuit

Durability:

100 cycles for 30μ" Gold (Au) plating

Physical

Housing:

High-Temperature Thermoplastic Glass Filled, UL 94V-0, Black Contact: Copper (Cu) Alloy

Plating:

Contact Area —30μ" (0.76μm) Gold (Au)

Gold (Au)

Signal Tail Area — Tin / Lead (Sn/Pb)

Underplating — Nickel (Ni)

RoHS Compliant: Yes – By Exemption Operating Temperature: -40 to +80°C zQuad Small Formfactor Pluggable Plus (zQSFP+) Interconnect System

EMI Cages

Reference Information

Packaging: Tray and Box

Mates With:

QSFP+ Cable Assemblies (Series 74757, 111040) QSFP+ Loopback Adapter

(Series 74763) zQSFP+ Cables (Series 11114)

Use With:

Connector (Series 170432) Designed In: Millimeters

Mechanical

Durability:

Die-Cast Cages: Attachment to PCB via screw-mount, enabling extensive attachments

Sheet-Metal Cages: 1 insertion to PCB

Sheet-Metal Cages:

1-by-1 Mating Force (max.): 544N in immersion gold 1-by-1 Unmating Force (max.):

88N in immersion gold 1-by-6 Mating Force (max.):

1427N in immersion gold

1-by-6 Unmating Force (max.): 226N in immersion gold

Physical — Die-Cast Cages

Cage and Clip Material: Stainless Steel Spring-Finger Material: Copper Alloy

Plating: Nickel (Ni)

RoHS Compliant: Yes – By Exemption Operating Temperature: -40 to +80°C

Physical — Sheet-Metal Cages

Die-Cast Cage: Aluminum

Die-Cast Heat-Sink Frame: Aluminum

Plating: Nickel (Ni)

Sheet Metal: Stainless Steel Light Pipe: Polycarbonate Heat Sink: Aluminum (Al) Heat Sink Finish: Nickel (Ni)

Operating Temperature: -55 to +105°C

BANDWIDTH REFERENCE CHART

Fiber Type	Overfilled Launch Bandwidth, Min (MHz-km)		1 Gigabit Ethernet Link Distance, Min (m)		10 Gigabit Ethernet Link Distance, Min (m)	
	850nm	1300nm	850nm	1300nm	850nm	1300nm
Standard Bandwidth	500	500	600	600	86	-
High Bandwidth	1500	500	900	550	300	-



Features and Benefits

zQuad Small Formfactor Pluggable Plus (zQSFP+) Interconnect System

SMT Connectors (Series 170432) and Stacked Integrated Connectors and Cages (Series 171565, 171722)

Preferential coupling design uses a narrow-edge coupled, blanked- and formed-contact geometry and insert molding	Provides superior signal integrity (SI) performance, including extremely low insertion loss (IL) of <0.8dB at a very high frequency, 14 GHz
Proven 25 Gbps data rate with potential up to 40 Gbps per lane	Meets or exceeds current requirements for 100 Gigabit Ethernet and InfiniBand* 100 Gigabit (EDR)applications. Supports current 10 Gbps Ethernet, 14 Gbps (FDR) InfiniBand and 16 Gbps Fibre Channel applications. Scalable for next-generation applications
Stacked integrated connectors include an elastomeric EMI gasket (Series 171565) or a metal EMI gasket (Series 171722)	Provides superior EMI containment and suppression
Identical mating interface as the QSFP+ connector for backward compatibility	Protects end user's current QSFP+ infrastructure investment
Surface Mount Technology (SMT) design (series 170432 version only)	Allows for ease of routing and provides the option for placement on both sides of the PCB
0.80mm pitch host connector designed for placement beneath EMI cage	Supports pluggable applications
Stacked integrated connectors and cages are available in three sizes (2-by-1, 2-by-2 and 2-by-3)	Offers design options for high-density applications
Drop-in replacement product from TE Connectivity	Second-source option available
Die-Cast EMI Cages (Series 111118 and 111186)	
Advanced heat-sink system	Provides a high level of heat dissipation at next- generation system-power levels
Die-cast frame design with reduced holes and openings	Provides optimal EMI suppression and shielding effectiveness
Same mechanical mating size as QSFP+ EMI cages	Provides backward compatibility with QSFP+ and QSFP modules and cable assemblies for legacy system connections
Through-hole-mount style to PCB with screws	Provides reliable retention to the PCB for both single- side and belly-to-belly applications

^{*}InfiniBand is a registered trademark of the InfiniBand Trade Association



Features and Benefits

zQuad Small Formfactor Pluggable Plus (zQSFP+) Interconnect System

Sheet-Metal (Stainless Steel) EMI Cages (Series 100014, 100017 and 100086)

Stainless steel cage construction	Offers increased robustness versus copper alloy material. Lowers material cost
3D-style press-fit pin design	Increased board retention versus standard press pins
Nickel-plated heat sink	Provides increased thermal transfer from module to heat sink
Offers up to four light pipes per port	Enables increased system functionality

Optical MPO/MTP* Cable Assemblies (Series 106283)

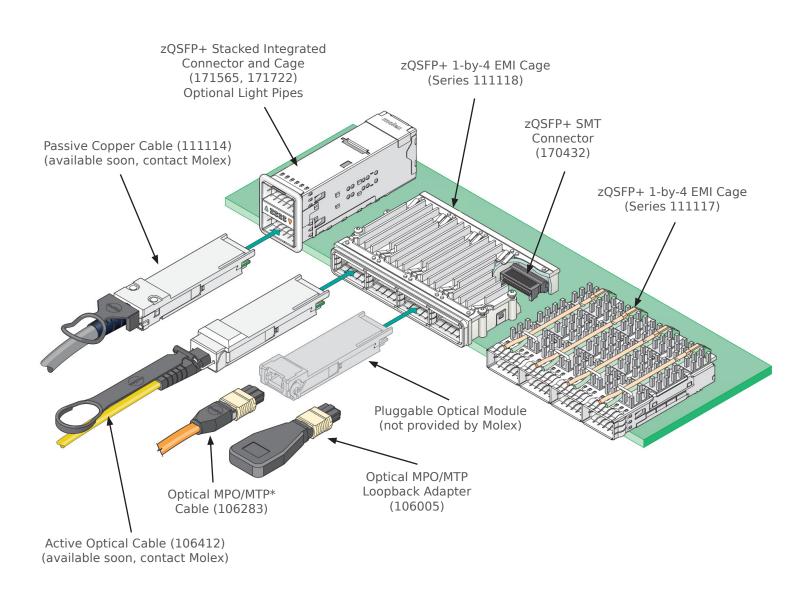
MTP/MPO QSFP+ connector interface	Meets QSFP+ SFF-8665 interface specification
Low-profile round cable	Improved cable management and flexibility for routing
Standard OM3 or OM4 fiber available	Optimized bandwidth for each application
MPO/MTP breakout to duplex LC available	Allows QSFP to SFP connectivityequipment and accessories
RoHS compliant design	Meets EU environmental requirements for electronic equipment and accessories

Optical MPO/MTP Loopback Adapters (Series 106005)

Compact housing	Compatible with module spacing
Enclosed fibers	No snagging or breakage of fiber/cable during installation and handling
Loop optical transmit ports to receive ports	Allows loopback testing of modules, cables during burn in and field troubleshooting



zQuad Small Formfactor Pluggable Plus (zQSFP+) Interconnect System





Applications

Telecommunication Equipment

- Hubs
- Servers
- Routers
- Switches
- Central office
- Cellular infrastructure and multiplatform service systems

Data Networking Equipment

- Servers
- Storage



Server Farm/Data Center

zQuad Small Formfactor Pluggable Plus (zQSFP+) Interconnect System

Ordering Information

SMT Connectors

Order No.	Circuits	Contact Material
<u>170432-0001</u>		0.381μm Gold
<u>170432-0002</u>	38	0.762µm Gold
<u>170432-0003</u>		Gold Flash

Stacked Integrated Connectors and Cages

Order No.	Port Size	Circuits	EMI Gasket	Light Pipe
171565-1002	2-by-1	38 circuits per port (76 circuits total)		
171565-0002	2-by-2	38 circuits per port (152 circuits total)	Elastomeric	
171565-3002	2-by-3	38 circuits per port (230 circuits total)		Arrow Up
171722-1002	2-by-1	38 circuits per port (76 circuits total)		and Down
171722-2002	2-by-2	38 circuits per port (152 circuits total)	Spring-Finger	
171722-3002	2-by-3	38 circuits per port (230 circuits total)		

EMI Cages

Series No.	Port Size	Cage Construction	Gasket Style	Pins	Light Pipes	Heat Sinks
<u>111118</u>	1-by-4	Die Cast	Flootomorio	Corour		
111186	1-by-6	Die Cast	Elastomeric	Screw		
100014	1-by-1				Optional	Optional
100017	1-by-4	Sheet Metal (Stainless Steel)	Spring Finger	3D Press-Fit Pin		
100086	1-by-6	(======================================				

Optical MPO/MTP* Cable Assemblies and Loopback Adapters

Series No.	Component	Length (m)	GBandwidth
106283	Cable Assembly	1.00 or 5.00m	Standard or High
<u>106005</u>	Loopback Adapter	N/A	N/A

^{*}MTP is a registered trademark of US Conec Ltd.

www.molex.com/link/zqsfp+.html